

22850
OBLON SPIVAK MCCLELLAND MAIER & NEUSTADT PC
FOURTH FLOOR
1755 JEFFERSON DAVIS HIGHWAY
ARLINGTON, VA 22202

CONFIRMATION NO. 4795

FILING RECEIPT



Date Mailed: 03/08/2001

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the PTO processes the reply to the Notice, the PTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Minoru Takaya, Tokyo, JAPAN;
Hisashi Kobuke, Tokyo, JAPAN;
Toshikazu Endo, Tokyo, JAPAN;
Seiji Takahara, Tokyo, JAPAN;
Toshiyuki Abe, Tokyo, JAPAN;
Hiroshige Ohkawa, Tokyo, JAPAN;
Masami Sasaki, Tokyo, JAPAN;
Kenichi Kawabata, Tokyo, JAPAN;

Assignment For Published Patent Application

TDK CORPORATION, Tokyo, JAPAN;

Continuing Data as Claimed by Applicant

Foreign Applications

JAPAN 11-373804 12/28/1999
JAPAN 11-373805 12/28/1999
JAPAN 11-373806 12/28/1999
JAPAN 11-373353 12/28/1999
JAPAN 11-375732 12/28/1999
JAPAN 2000-68364 03/13/2000
JAPAN 2000-121629 04/21/2000
JAPAN 2000-147591 05/19/2000
JAPAN 11-375753 12/28/1999

RECEIVED
MAR 12 2001

OBLON, SPIVAK, MCCLELLAND

If Required, Foreign Filing License Granted 03/06/2001

Projected Publication Date: 06/28/2001

Non-Publication Request: No

Early Publication Request: No

Title

Composite dielectric material, composite dielectric substrate, prepreg, coated metal foil, molded sheet, composite magnetic substrate, substrate, double side metal foil-clad substrate, flame retardant substrate, polyvinylbenzyl ether resin composition, thermosetting polyvinylbenzyl ether resin composition, and method for preparing thermosetting polyvinylbenzyl ether resin composition

Preliminary Class

524

Data entry by : NGUYEN, TRAC

Team : OIPE

Date: 03/08/2001

1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 19 20 21 22 23 24 25 26 27 28 29 30 31 32 33 34 35 36 37 38 39 40 41 42 43 44 45 46 47 48 49 50 51 52 53 54 55 56 57 58 59 60 61 62 63 64 65 66 67 68 69 70 71 72 73 74 75 76 77 78 79 80 81 82 83 84 85 86 87 88 89 90 91 92 93 94 95 96 97 98 99 100

PLEASE NOTE THAT THE SEVENTH FOREIGN APPLICATION NUMBER HAS BEEN OMITTED. IT SHOULD READ AS FOLLOWS:

7TH - JAPAN 2000-68366 03/13/00